SEMIX105GD12T4



SEMiX® 5

Trench IGBT Modules

Evaluation Sample SEMiX105GD12T4

Target Data

Features

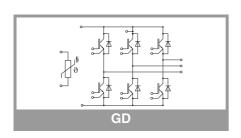
- Solderless assembling solution with PressFIT signal pins and screw power terminals
- IGBT 4 Trench Gate Technology
- V_{CE(sat)} with positive temperature coefficient
- Low inductance case
- Reliable mechanical design with injection moulded terminals and reliable internal connections
- UL recognized file no. E63532
- NTC temperature sensor inside

Typical Applications*

- · AC inverter drives
- UPS
- Electronic Welding

Remarks

- Product reliability results are valid for $T_{\text{jop}} {=} 150~^{\circ}\text{C}$
- · Dynamic data are estimated
- For storage and case temperature with TIM see document "TP(HALA P8) SEMiX 5p"



Absolute	Maximum Ratin	gs		
Symbol	Conditions		Values	Unit
IGBT				
V _{CES}	T _j = 25 °C		1200	V
Ic	T _j = 175 °C	T _c = 25 °C	163	Α
		T _c = 80 °C	126	Α
I _{Cnom}			100	Α
I _{CRM}	$I_{CRM} = 3xI_{Cnom}$		300	Α
V_{GES}			-20 20	V
t _{psc}	$V_{CC} = 800 \text{ V}$ $V_{GE} \le 20 \text{ V}$ $V_{CES} \le 1200 \text{ V}$	T _j = 150 °C	10	μs
Tj			-40 175	°C
Inverse d	liode	<u>. </u>		•
V _{RRM}	T _j = 25 °C		1200	V
I _F	T _j = 175 °C	T _c = 25 °C	129	Α
		T _c = 80 °C	97	Α
I _{Fnom}			100	Α
I _{FRM}	I _{FRM} = 2xI _{Fnom}		200	Α
I _{FSM}	$t_p = 10 \text{ ms, sin } 180^{\circ}, T_j = 25 ^{\circ}\text{C}$		550	
Tj			-40 175	°C
Module	<u> </u>	<u>. </u>		•
I _{t(RMS)}			280	Α
T _{stg}	module without TIM		-40 125	°C
V _{isol}	AC sinus 50Hz, t = 1 min		4000	V

Characteristics							
Symbol	Conditions		min.	typ.	max.	Unit	
IGBT	•					•	
• CEISall	$I_{\rm C} = 100 {\rm A}$	T _j = 25 °C		1.80	2.05	٧	
	V _{GE} = 15 V chiplevel	T _j = 150 °C		2.20	2.40	V	
V _{CE0}	chiplevel	T _j = 25 °C		0.80	0.90	V	
		T _j = 150 °C		0.70	0.80	V	
r _{CE}	V _{GE} = 15 V chiplevel	T _j = 25 °C		10.0	12	mΩ	
		T _j = 150 °C		15	16	mΩ	
$V_{GE(th)}$	$V_{GE}=V_{CE}$, $I_{C}=3.8$ m	nA	5	5.8	6.5	V	
I _{CES}	$V_{GE} = 0 \text{ V}, V_{CE} = 12$	00 V, T _j = 25 °C			1.0	mA	
C _{ies}	V 05.V	f = 1 MHz		6.2		nF	
Coes	$V_{CE} = 25 \text{ V}$ $V_{GE} = 0 \text{ V}$	f = 1 MHz		0.41		nF	
C _{res}		f = 1 MHz		0.35		nF	
Q_{G}	V _{GE} = - 15 V+ 15 V			565		nC	
R _{Gint}	T _j = 25 °C			7.5		Ω	
t _{d(on)}	$V_{CC} = 600 \text{ V}$	T _j = 150 °C		t.b.d.		ns	
t _r	$\begin{array}{l} I_C = 100 \text{ A} \\ V_{GE} = +15/\text{-}15 \text{ V} \\ R_{G \text{ on}} = 1 \Omega \\ R_{G \text{ off}} = 1 \Omega \\ \text{di/dt}_{on} = 2300 \text{ A/}\mu\text{s} \\ \text{di/dt}_{off} = 800 \text{ A/}\mu\text{s} \end{array}$	T _j = 150 °C		t.b.d.		ns	
E _{on}		T _j = 150 °C		12		mJ	
t _{d(off)}		T _j = 150 °C		t.b.d.		ns	
t _f		T _j = 150 °C		t.b.d.		ns	
E _{off}		T _j = 150 °C		19		mJ	
R _{th(j-c)}	per IGBT				0.26	K/W	
R _{th(c-s)}	per IGBT (λgrease=0.81 W/mK, thickness 50-100μm)			t.b.d.		K/W	
R _{th(c-s)}	per IGBT (λ=3.4 W/mK)			t.b.d.		K/W	

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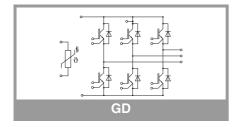
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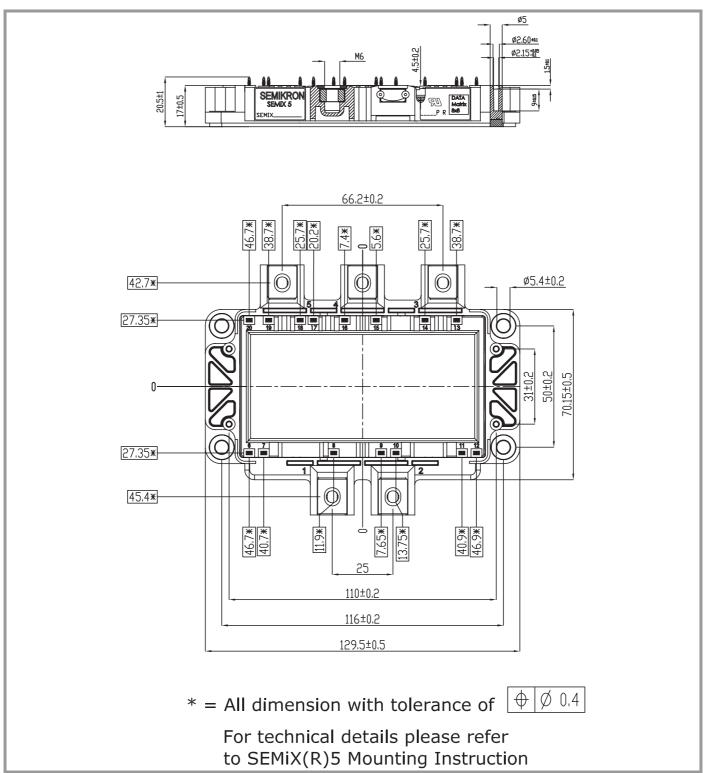
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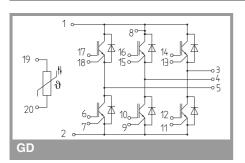
Characte	ristics					
Symbol	Conditions		min.	typ.	max.	Unit
Inverse d	iode					•
$V_F = V_{EC}$	I _F = 100 A	T _j = 25 °C		2.20	2.52	V
	V _{GE} = 0 V chiplevel	T _j = 150 °C		2.15	2.47	V
V_{F0}	chiplevel	T _j = 25 °C		1.30	1.50	V
		T _j = 150 °C		0.90	1.10	V
r _F	chiplevel	T _j = 25 °C		9.0	10	$m\Omega$
		T _j = 150 °C		13	14	mΩ
I _{RRM}	$I_F = 100 \text{ A}$ $di/dt_{off} = 2300 \text{ A/}\mu\text{s}$ $V_{GE} = -15 \text{ V}$ $V_{CC} = 600 \text{ V}$	T _j = 150 °C		-		Α
Q _{rr}		T _j = 150 °C		-		μC
E _{rr}		T _j = 150 °C		12		mJ
R _{th(j-c)}	per diode				0.43	K/W
R _{th(c-s)}	per diode (λgrease=0.81 W/mK, thickness 50-100μm)			t.b.d.		K/W
R _{th(c-s)}	per diode (λ=3.4 W/mK)			t.b.d.		K/W
Module	•					•
L _{CE}				20		nΗ
R _{CC'+EE'}	measured per	T _C = 25 °C		1.2		mΩ
	switch	T _C = 125 °C		1.65		mΩ
Rth _{(c-s)1}	calculated without thermal coupling			t.b.d.		K/W
Rth _{(c-s)2}	including thermal coupling, Ts underneath module $(\lambda_{grease}=0.81 \text{ W/} (\text{m}^{\star}\text{K}))$			t.b.d.		K/W
Rth _{(c-s)2}	including thermal coupling, Ts underneath module, pre-applied phase change material			t.b.d.		K/W
Ms	to heat sink (M5)		3		6	Nm
Mt		to terminals (M6)	3		6	Nm
]					Nm
W				398		g
Temperat	ure Sensor					_
R ₁₀₀	T_c =100°C (R_{25} =5 k Ω)			493 ± 5%		Ω
B _{100/125}	$R_{(T)} = R_{100} exp[B_{100/125}(1/T-1/T_{100})]; T[K];$			3550 ±2%		К



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SEMiX5p



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This is an electrostatic discharge sensitive device (ESDS), international standard IEC 60747-1, chapter IX.

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